

January 1998

- 6.2A and 5.4A, 600V
- $r_{DS(ON)} = 1.2\Omega$  and  $1.6\Omega$
- Repetitive Avalanche Energy Rated
- Simple Drive Requirements
- Ease of Paralleling
- Related Literature
  - TB334, "Guidelines for Soldering Surface Mount Components to PC Boards"

### Ordering Information

PART NUMBER	PACKAGE	BRAND
IRFAC40	TO-204AA	IRFAC40
IRFAC42	TO-204AA	IRFAC42

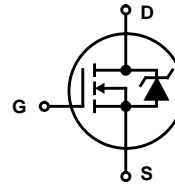
NOTE: When ordering, include the entire part number.

### Description

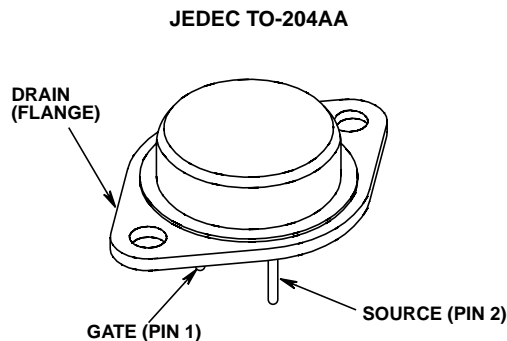
These are N-Channel enhancement mode silicon gate power field effect transistors. They are advanced power MOSFETs designed, tested, and guaranteed to withstand a specified level of energy in the breakdown avalanche mode of operation. All of these power MOSFETs are designed for applications such as switching regulators, switching converters, motor drivers, relay drivers, and drivers for high power bipolar switching transistors requiring high speed and low gate drive power. These types can be operated directly from integrated circuits.

Formerly Developmental Type TA17426.

### Symbol



### Packaging



## IRFAC40, IRFAC42

### Absolute Maximum Ratings $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

	IRFAC40	IRFAC42	UNITS
Drain to Source Breakdown Voltage (Note 1) . . . . .	$V_{DS}$ 600	600	V
Drain to Gate Voltage ( $R_{GS} = 20k\Omega$ ) (Note 1) . . . . .	$V_{DGR}$ 600	600	V
Continuous Drain Current . . . . .	$I_D$ 6.2	5.4	A
$T_C = 100^\circ\text{C}$ . . . . .	$I_D$ 3.9	3.4	A
Pulsed Drain Current (Note 2) . . . . .	$I_{DM}$ 25	22	A
Gate to Source Voltage . . . . .	$V_{GS}$ $\pm 20$	$\pm 20$	V
Maximum Power Dissipation . . . . .	$P_D$ 125	125	W
Linear Derating Factor . . . . .	1.0	1.0	W/ $^\circ\text{C}$
Single Pulse Avalanche Energy Rating (Note 3) (Figures 15, 16) . . . . .	$E_{AS}$ 570	570	mJ
Operating and Storage Temperature . . . . .	$T_J, T_{STG}$ -55 to 150	-55 to 150	$^\circ\text{C}$
Maximum Temperature for Soldering			
Leads at 0.063in (1.6mm) from Case for 10s . . . . .	$T_L$ 300	300	$^\circ\text{C}$
Package Body for 10s, See Techbrief 334 . . . . .	$T_{pkg}$ 260	260	$^\circ\text{C}$

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

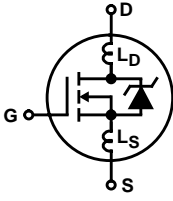
- $T_J = 25^\circ\text{C}$  to  $125^\circ\text{C}$ .

### Electrical Specifications $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified

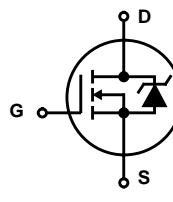
PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNITS	
Drain to Source Breakdown Voltage	$BV_{DSS}$	$V_{GS} = 0V, I_D = 250\mu\text{A}$ (Figure 10)	600	-	-	V	
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{GS} = V_{DS}, I_D = 250\mu\text{A}$	2.0	-	4.0	V	
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = \text{Rated } BV_{DSS}, V_{GS} = 0V$	-	-	25	$\mu\text{A}$	
		$V_{DS} = 0.8 \times \text{Rated } BV_{DSS}, V_{GS} = 0V$ $T_J = 125^\circ\text{C}$	-	-	250	$\mu\text{A}$	
On-State Drain Current (Note 4)	$I_{D(ON)}$	$V_{DS} > I_{D(ON)} \times r_{DS(ON) \text{ MAX}}, V_{GS} = 10V$					
IRFAC40			6.2	-	-	$\mu\text{A}$	
IRFAC42	5.4	-	-	$\mu\text{A}$			
Gate to Source Leakage	$I_{GSS}$	$V_{GS} = \pm 20V$	-	-	$\pm 100$	nA	
Drain to Source On Resistance (Note 2)	$r_{DS(ON)}$	$V_{GS} = 10V, I_D = 3.4A$ (Figures 8, 9)					
IRFAC40			-	0.97	1.2	$\Omega$	
IRFAC42	-	1.2	1.6	$\Omega$			
Forward Transconductance (Note 4)	$g_{fs}$	$V_{DS} \geq 50V, I_D = 3.4A$ (Figure 12)	4.7	70	-	S	
Turn-On Delay Time	$t_{d(ON)}$	$V_{DD} = 0.5V \times \text{Rated } BV_{DSS}, I_D = 6.2A, R_G = 9.1\Omega, R_L = 47\Omega, V_{GS} = 10V$ (Figures 17, 18) MOSFET Switching Times are Essentially Independent of Operating Temperature	-	13	20	ns	
Rise Time	$t_r$		-	18	27	ns	
Turn-Off Delay Time	$t_{d(OFF)}$		-	55	83	ns	
Fall Time	$t_f$		-	20	30	ns	
Total Gate Charge (Gate to Source + Gate to Drain)	$Q_g(\text{TOT})$	$V_{GS} = 10V, I_D = 6.2A, V_{DSS} = 0.8 \times \text{Rated } BV_{DSS}, I_{G(\text{REF})} = 1.5\text{mA}$ (Figures 14, 19, 20) Gate Charge is Essentially Independent of Operating Temperature	-	40	60	nC	
Gate to Source Charge			$Q_{gs}$	-	5.5	-	nC
Gate to Drain "Miller" Charge			$Q_{gd}$	-	20	-	nC

## IRFAC40, IRFAC42

### Electrical Specifications $T_C = 25^\circ\text{C}$ , Unless Otherwise Specified (Continued)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNITS
Input Capacitance	$C_{ISS}$	$V_{GS} = 0\text{V}$ , $V_{DS} = 25\text{V}$ , $f = 1.0\text{MHz}$ (Figure 11)		-	1300	-	pF
Output Capacitance	$C_{OSS}$			-	160	-	pF
Reverse Transfer Capacitance	$C_{RSS}$			-	30	-	pF
Internal Drain Inductance	$L_D$	Measured Between the Contact Screw on the Flange that is Closer to Source and Gate Pins and the Center of Die	Modified MOSFET Symbol Showing the Internal Devices Inductances 	-	5.0	-	nH
Internal Source Inductance	$L_S$	Measured From The Source Lead, 6mm (0.25in) From the Flange and the Source Bonding Pad		-	13	-	nH
Thermal Resistance Junction to Case	$R_{\theta JC}$			-	-	1.0	$^\circ\text{C/W}$
Thermal Resistance Junction to Ambient	$R_{\theta JA}$	Free Air Operation		-	-	30	$^\circ\text{C/W}$

### Source to Drain Diode Specifications

PARAMETER	SYMBOL	TEST CONDITIONS		MIN	TYP	MAX	UNITS
Continuous Source to Drain Current	$I_{SD}$	Modified MOSFET Symbol Showing the Integral Reverse P-N Junction Diode 		-	-	6.2	A
Pulse Source to Drain Current (Note 3)	$I_{SDM}$			-	-	25	A
Source to Drain Diode Voltage (Note 2)	$V_{SD}$	$T_J = 25^\circ\text{C}$ , $I_{SD} = 6.2\text{A}$ , $V_{GS} = 0\text{V}$ , (Figure 13)		-	-	1.5	V
Reverse Recovery Time	$t_{rr}$	$T_J = 25^\circ\text{C}$ , $I_{SD} = 6.2\text{A}$ , $dI_{SD}/dt = 100\text{A}/\mu\text{s}$		200	450	940	ns
Reverse Recovered Charge	$Q_{RR}$	$T_J = 25^\circ\text{C}$ , $I_{SD} = 6.2\text{A}$ , $dI_{SD}/dt = 100\text{A}/\mu\text{s}$		1.8	3.8	7.9	$\mu\text{C}$

**NOTES:**

2. Pulse test: pulse width  $\leq 300\mu\text{s}$ , duty cycle  $\leq 2\%$ .
3. Repetitive rating: pulse width limited by Max junction temperature. See Transient Thermal Impedance curve (Figure 3).
4.  $V_{DD} = 50\text{V}$ , starting  $T_J = 25^\circ\text{C}$ ,  $L = 16\text{mH}$ ,  $R_G = 25\Omega$ , peak  $I_{AS} = 6.8\text{A}$ . See Figures 15, 16.

# IRFAC40, IRFAC42

## Typical Performance Curves Unless Otherwise Specified

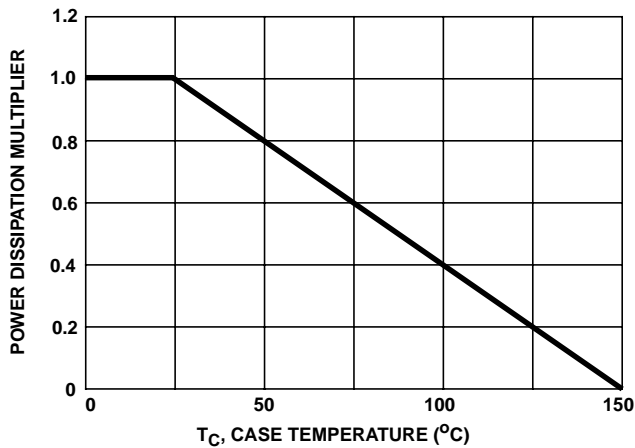


FIGURE 1. NORMALIZED POWER DISSIPATION vs CASE TEMPERATURE

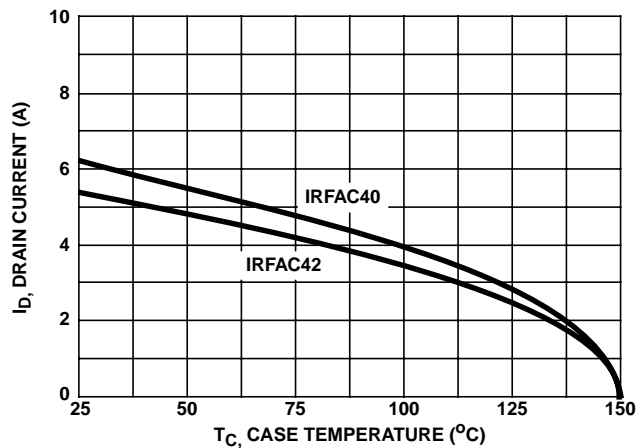


FIGURE 2. MAXIMUM CONTINUOUS DRAIN CURRENT vs CASE TEMPERATURE

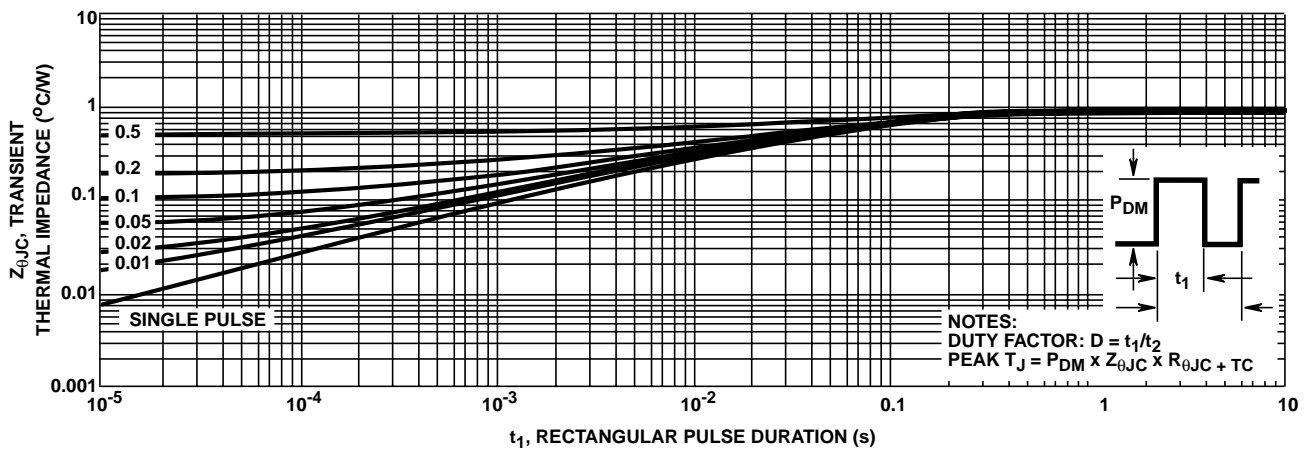


FIGURE 3. MAXIMUM TRANSIENT THERMAL IMPEDANCE

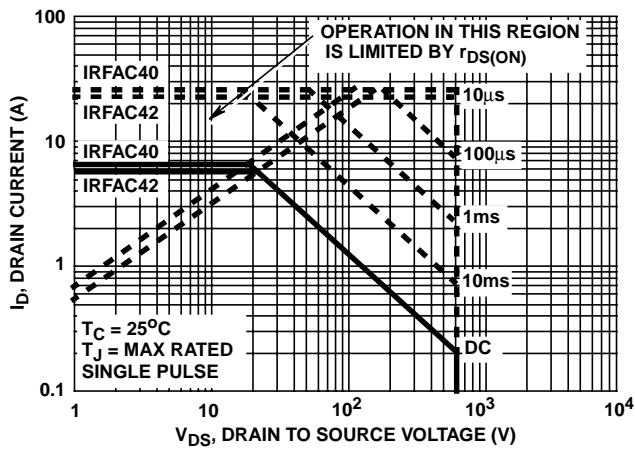


FIGURE 4. FORWARD BIAS SAFE OPERATING AREA

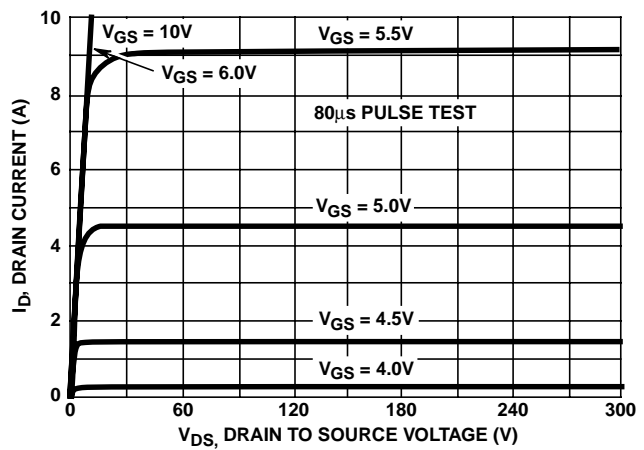


FIGURE 5. OUTPUT CHARACTERISTICS

Typical Performance Curves Unless Otherwise Specified (Continued)

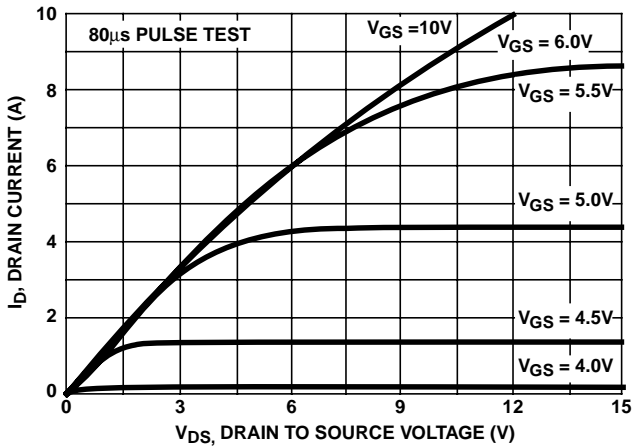


FIGURE 6. SATURATION CHARACTERISTICS

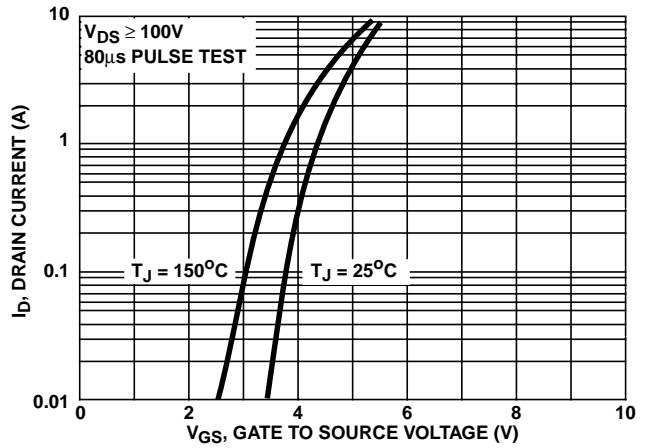


FIGURE 7. TRANSFER CHARACTERISTICS

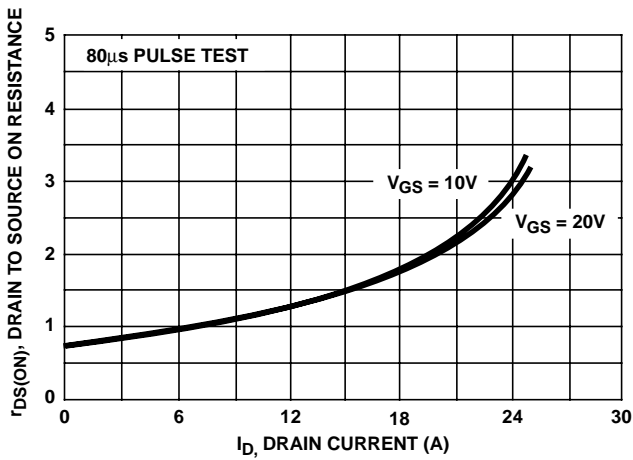


FIGURE 8. DRAIN TO SOURCE ON RESISTANCE vs GATE VOLTAGE AND DRAIN CURRENT

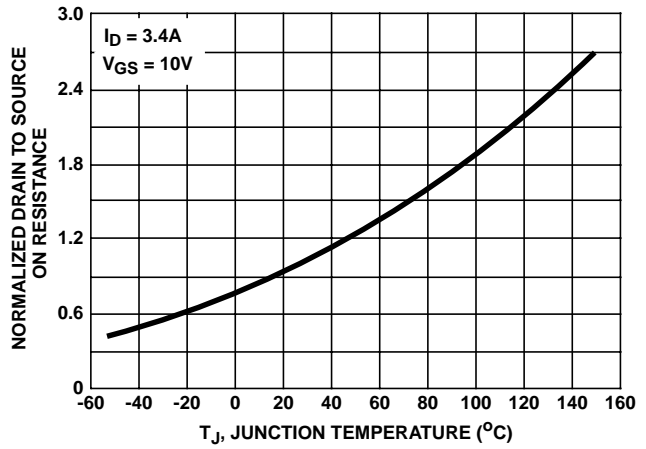


FIGURE 9. NORMALIZED DRAIN TO SOURCE ON RESISTANCE vs JUNCTION TEMPERATURE

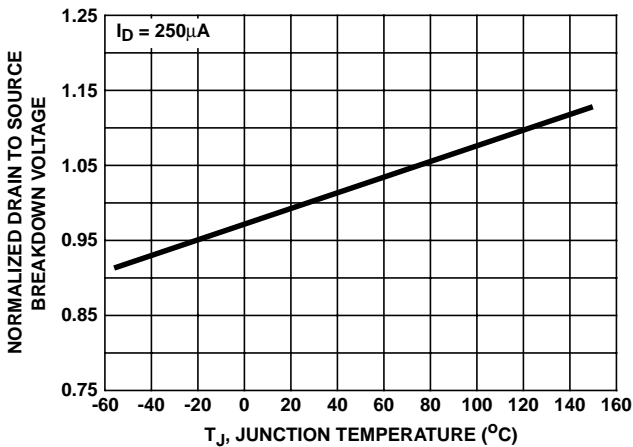


FIGURE 10. NORMALIZED DRAIN TO SOURCE BREAKDOWN VOLTAGE vs JUNCTION TEMPERATURE

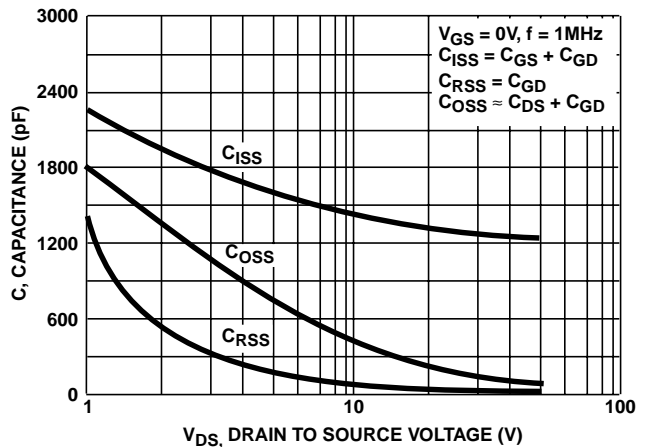


FIGURE 11. CAPACITANCE vs DRAIN TO SOURCE VOLTAGE

**Typical Performance Curves** Unless Otherwise Specified (Continued)

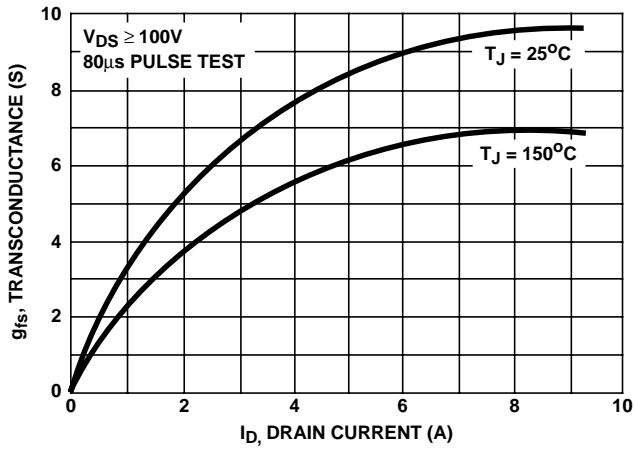


FIGURE 12. TRANSCONDUCTANCE vs DRAIN CURRENT

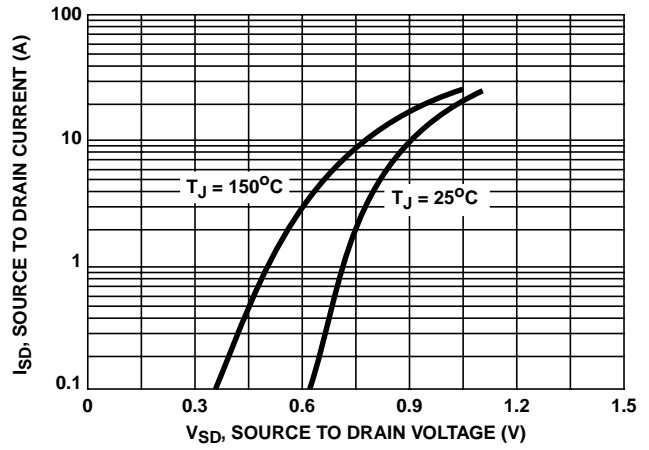


FIGURE 13. SOURCE TO DRAIN DIODE VOLTAGE

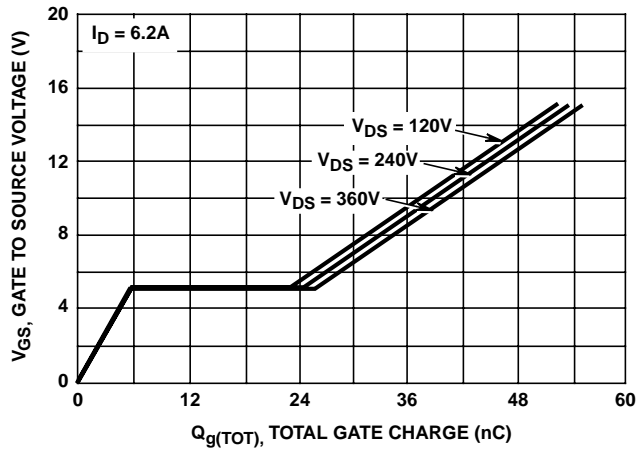


FIGURE 14. GATE TO SOURCE VOLTAGE vs GATE CHARGE

Test Circuits and Waveforms

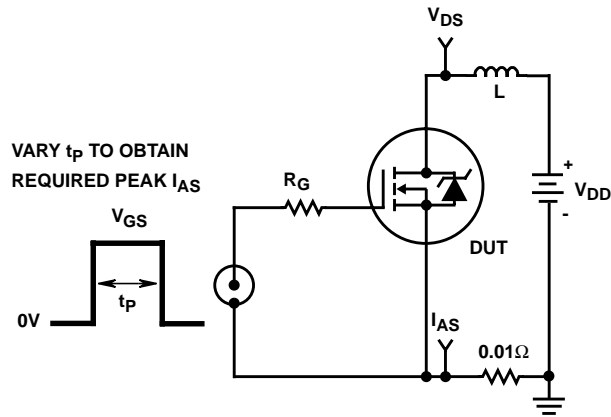


FIGURE 15. UNCLAMPED ENERGY TEST CIRCUIT

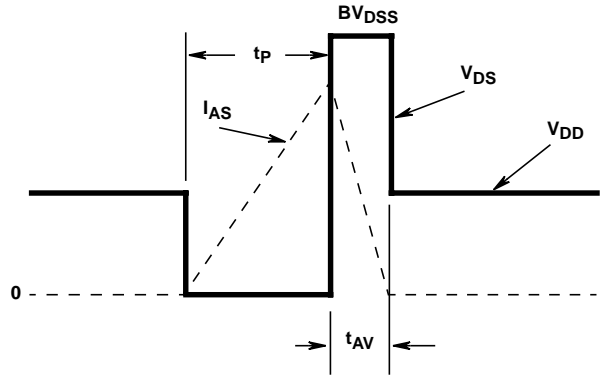


FIGURE 16. UNCLAMPED ENERGY WAVEFORMS

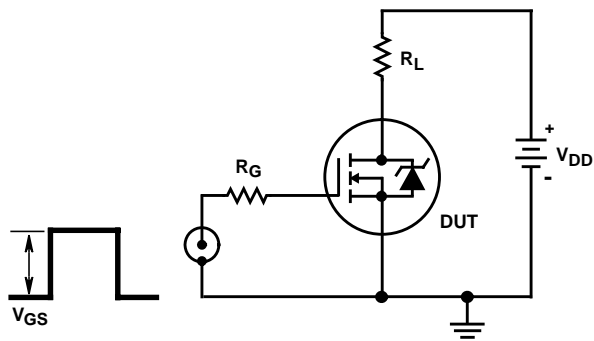


FIGURE 17. SWITCHING TIME TEST CIRCUIT

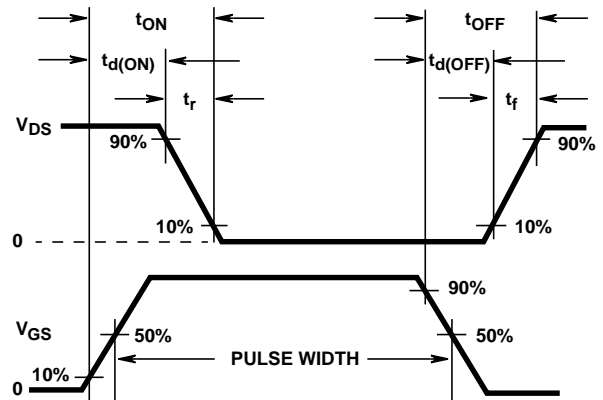


FIGURE 18. RESISTIVE SWITCHING WAVEFORMS

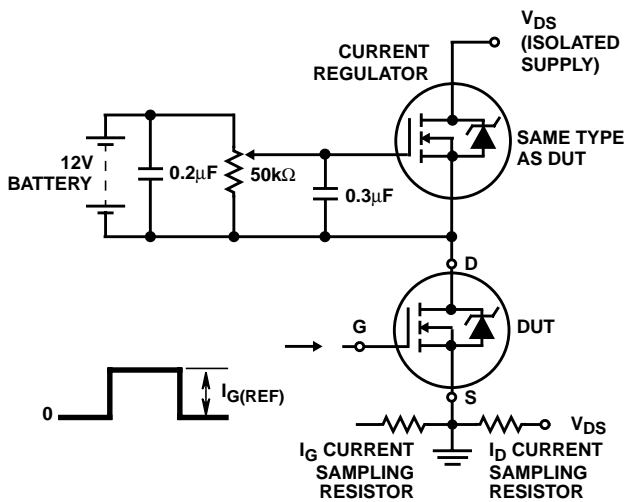


FIGURE 19. GATE CHARGE TEST CIRCUIT

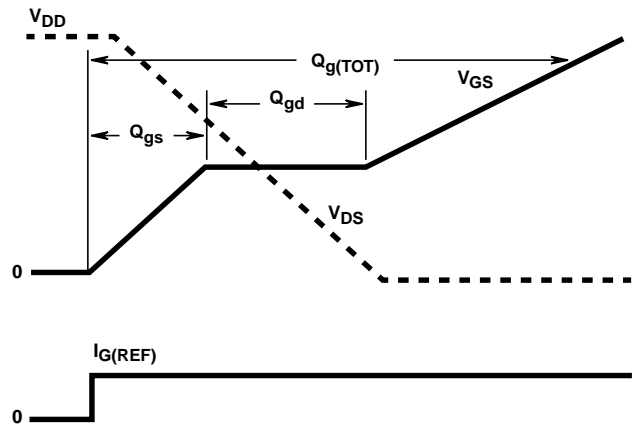


FIGURE 20. GATE CHARGE WAVEFORMS

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